

# 78 Series Regulators

# 1A Output 78 series Regulators 500mA Output 78 series Regulators





BA78□□Series,BA78M□□Series

No.12019ECT01

#### Description

#### Features

- 1) Built-in over-current protection circuit and thermal shutdown circuit
- 2) High ripple rejection
- 3) Available TO220CP-3, TO252-3 package to a wide range application
- 4) Compatible replacement to competitor products
- 5) Various voltage lineup (5V, 6V, 7V, 8V, 9V, 10V, 12V, 15V, 18V, 20V, 24V)

#### Applications

Fixed voltage power supply for TV, Audio components, etc

#### ●Line up

#### ■1A BA78□□Series

Part Number	5V	6V	7V	8V	9V	10V	12V	15V	18V	20V	24V	Package
ВА78□□СР	0	0	0	0	0	0	0	0	0	0	0	TO220CP-3
BA78□□FP	0	0	0	0	0	0	0	0	0	0	0	TO252-3

#### ■0.5A BA78M□□Series

Edicit Britain Edecide												
Part Number	5V	6V	7V	8V	9V	10V	12V	15V	18V	20V	24V	Package
ВА78М□□СР	0	0	0	0	0	0	0	0	0	0	0	TO220CP-3
BA78M□□FP	0	0	0	0	0	0	0	0	0	0	0	TO252-3

# Output Voltage and Marking

Symbol	assignment of output voltage								
		Output voltage(V)		Output voltage(V)					
	05	5.0V typ.	12	12V typ.					
	06	6.0V typ.	15	15V typ.					
а	07	7.0V typ.	18	18V typ.					
	08	8.0V typ.	20	20V typ.					
	09	9.0V typ.	24 24V typ.						
	10	10.0V typ.							
		Package							
		CP : TO220CP-3							
b	FP: TO252-3								

Symbol		assignment of output voltage							
		Output voltage(V)		Output voltage(V)					
	05	5.0V typ.	12	12V typ.					
	06	6.0V typ.	15	15V typ.					
а	07	7.0V typ.	18	18V typ.					
	08	8.0V typ.	20	20V typ.					
	09	9.0V typ. 24 24V typ							
	10	10.0V typ.							
	ı	Package							
		CP : TO220CP-3							
b	FP: TO252-3								

# ● Absolute Maximum Rating (Ta=25°C)

BA78 CP/FP, BA78M CP/FP

Para	meter	Symbol	Limits	Unit	
Power supply voltage		Vin	35	V	
Power Dissipation 1	TO220CP-3	Pd1	2 *1	W	
Power Dissipation i	TO252-3	Pui	1 *1	VV	
Dower Dissipation 2	TO220CP-3	Pd2	22 *2	W	
Power Dissipation 2	TO252-3	Fu2	10 <sup>*2</sup>	VV	
Output Current	BA78□□	lo	1 *3	۸	
Output Current	BA78□□M	10	0.5 *3	A	
Operating Temperatur	re Range	Topr	-40~+85	°C	
Storage Temperature	Range	Tstg	-55~+150	°C	
Operating Junction Te	emperature Range	Tj	-40 <b>~</b> +150	°C	

#### ●Operating Conditions(Ta=25°C, Pd should not be exceeded) BA78□□CP/FP

Para	ameter	Symbol	Min.	Max.	Unit.
	BA7805		7.5	25	
	BA7806		8.5	21	
	BA7807		9.5	22	,
	BA7808		10.5	23	,
Innut	BA7809		11.5	26	
Input Voltage	BA7810	Vin	12.5	25	V
voltage	BA7812		14.5	27	
	BA7815		17.5	30	
	BA7818		21	33	
	BA7820		23	33	Ī
	BA7824		27	33	
Output C	urrent	lo	-	1	Α

# BA78M□□CP/FP

Par	ameter	Symbol	Min.	Max.	Unit.		
	BA78M05		7.5	25			
	BA78M06		8.5	21			
	BA78M07		9.5	22			
	BA78M08		10.5	23			
loout	BA78M09		11.5	26	V		
Input Voltage	BA78M10	Vin	12.5	25			
vollage	BA78M12		14.5	27			
	BA78M15		17.5	30			
	BA78M18		21	33			
	BA78M20		23	33			
	BA78M24		27	33			
Output C	urrent	lo	-	0.5	Α		

<sup>\*1</sup> Derating in done 16mW/°C(TO220CP-3), 8mW/°C(TO252-3) for temperatures above Ta=25°C
\*2 Derating in done 176mW/°C(TO220CP-3), 80mW/°C(TO252-3) for temperatures above Ta=25°C, Mounted on infinity Alminium heat sink.

<sup>\*3</sup> Pd,ASO and Tjmax(150°C) should not be exceeded.

# ● Electrical Characteristics BA78M□□CP/FP

 $(Ta=25^{\circ}C, Vin=10V(05), 11V(06), 13V(07), 14V(08), 15V(09), 16V(10), 19V(12), 23V(15), 27V(18), 29V(20), 33V(24), \ lo=350mA \ unless \ otherwise \ specified)$ 

		8),15V(09),16V(10),19V(12),23\ 		Limit						
Parameter	Symbol	Туре	Min	Тур	Max	Unit	Condition			
		05	4.8	5.0	5.2					
		06	5.75	6.0	6.25					
		07	6.7	7.0	7.3					
		08	7.7	8.0	8.3					
	Vo1	09	8.6	9.0	9.4					
Output Voltage 1		10	9.6	10.0	10.4	V	Io=350mA			
, ,		12	11.5	12.0	12.5	1				
		15	14.4	15.0	15.6					
		18	17.3	18.0	18.7					
		20	19.2	20.0	20.8					
		24	23.0	24.0	25.0					
		05	4.75	-	5.25		Vin=7.5~20V, Io=5mA~350mA			
		06	5.7	-	6.3		Vin=8.5~21V, Io=5mA~350mA			
		07	6.65	-	7.35		Vin=9.5~22V, Io=5mA~350mA			
		08	7.6	-	8.4		Vin=10.5~23V, Io=5mA~350mA			
		09	8.55	-	9.45		Vin=11.5~24V, Io=5mA~350mA			
Output Voltage 2	Vo2	10	9.5	-	10.5	V	Vin=12.5~25V, Io=5mA~350mA			
		12	11.4	-	12.6		Vin=15~27V, Io=5mA~350mA			
		15	14.25	-	15.75		Vin=17.5~30V, Io=5mA~350mA			
		18	17.1	-	18.9		Vin=21~33V, Io=5mA~350mA			
		20	19.0	-	21.0		Vin=23~33V, Io=5mA~350mA			
		24	22.8	-	25.2		Vin=27~33V, Io=5mA~350mA			
		05	-	3	100		Vin=7~25V, Io=200mA			
		06	-	3	100		Vin=8~25V, Io=200mA			
		07	-	4	100		Vin=9~25V, Io=200mA			
		08	-	4	100		Vin=10.5~25V, Io=200mA			
Line Regulation 1		09	-	4	100		Vin=11.5~26V, Io=200mA			
	Reg.I1	10	-	5	100	mV	Vin=12.5~28V, Io=200mA			
		12	-	5	100		Vin=14.5~30V, Io=200mA			
		15	-	6	100		Vin=17.5~30V, Io=200mA			
		18	-	7	100		Vin=21~33V, Io=200mA			
		20	-	8	100		Vin=23~33V, Io=200mA			
		24	-	10	100		Vin=27~33V, Io=200mA			
		05	-	1	50		Vin=8~12V, Io=200mA			
		06	-	1	50		Vin=9~25V, Io=200mA			
		07	-	1	50		Vin=10~25V, Io=200mA			
		08	-	1	50		Vin=11~25V, Io=200mA			
		09	-	2	50		Vin=12~25V, Io=200mA			
Line Regulation 2	Reg.I2	10	-	2	50	mV	Vin=14~26V, Io=200mA			
		12	-	3	50		Vin=16~30V, Io=200mA			
		15	-	3	50		Vin=20~30V, Io=200mA			
		18	-	3	50		Vin=24~33V, Io=200mA			
		20	-	4	50		Vin=24~33V, Io=200mA			
		24	-	5	50		Vin=28~33V, Io=200mA			
		05	62	78	-					
		06	60	74	-					
		07	57	71	-					
		08	56	69	-					
		09	56	67	-					
Ripple Rejection	R.R.	10	56	66	-	dB	ein=1Vrms, f=120Hz, Io=100mA			
		12	55	63	-					
		15	54	60	-					
		18	53	58	-	]				
		20	53	58	_					
	<u></u>	24	50	55	-	<u> </u>				
Ta an a made ::::		05	-	-1.0	-					
Temperature	T	06/07/08/09/10/12	-	-0.5	-	~\\/\°	In FmA Ti 0 405°0			
Coefficient of	Tcvo	15/18	-	-0.6	-	mV/°C	lo=5mA, Tj=0~125°C			
Output Voltage		20/24	-	-0.7	-	1				
Peak Output Current	Іо-р	common	-	875	-	mA	Tj=25°C			
· car carpar carrors										

# ● Electrical Characteristics BA78M□□CP/FP

 $(Ta=25^{\circ}\text{C}, Vin=10\text{V}(05), 11\text{V}(06), 13\text{V}(07), 14\text{V}(08), 15\text{V}(09), 16\text{V}(10), 19\text{V}(12), 23\text{V}(15), 27\text{V}(18), 29\text{V}(20), 33\text{V}(24), lo=350\text{mA} \text{ unless otherwise specified})$ 

Parameter	Symbol	Туре	Min	Limit Typ	Max	Unit	Condition	
		05	-	20	100			
		06	-	20	120			
		07	-	20	140			
		08	-	20	160			
	Reg.L1	09	-	20	180			
Load Regulation 1		10	-	20	200	mV	Io=5mA~500mA	
		12	-	20	240			
		15	-	20	300			
		18	_	20	360			
		20	_	20	400			
		24	_	20	480			
		05	-	10	50			
		06	_	10	60			
		07	_	10	70			
		08		10	80			
		09	-	10	90			
Load Regulation 2	Reg.L2	10	-	10	100	mV	Io=5mA~200mA	
Loau Negulation 2	INGY.LZ	12	-	10	120	1117	IO-OHIA: - ZUUHIA	
		15	-	10	150	1		
		18	-	10	180	1		
		20		10	200			
			-					
		24	-	10	240		+	
		05 06	-	40	-			
		06	-	60 70	-			
			-		<b>†</b>			
		08	-	80	-			
Output Noise	.,	09	-	90	-	.,		
Voltage	Vn	10	-	100	-	μV	f=10Hz~100kHz	
•		12	-	110	-			
		15	-	130	-			
		18	-	140	-			
		20	-	150	-			
		24	-	170	-			
Bias Current	lb	common	-	4.5	6.0	mA	Io=0mA	
Bias Current Change1	lb1	common	-	-	0.5	mA	Io=5mA~350mA	
		05	-	-	0.8		Vin:8~25V, Io=200mA	
		06	-	-	8.0		Vin:9~25V, Io=200mA	
		07	-	-	8.0		Vin:10~25V, Io=200mA	
		08	-	-	0.8		Vin:10.5~25V, Io=200mA	
		09	-	-	0.8		Vin:12~25V, Io=200mA	
Bias Current Change 2	lb2	10	-	-	0.8	mA	Vin:13~25V, Io=200mA	
		12	-	-	0.8		Vin:14.5~30V, Io=200mA	
		15	-	-	0.8		Vin:17.5~30V, Io=200mA	
		18	-	-	0.8		Vin:21~33V, Io=200mA	
		20	-	-	0.8		Vin:23~33V, Io=200mA	
		24	-	-	0.8		Vin:27~33V, Io=200mA	
Short-Circuit	le-	05/06/07/08	-	0.4	-		Vin=25V	
Output Current	los	09/10/12/15/18/20/24	-	0.17	-	Α	Vin=30V	
•		05	-	9	-			
		06	-	10	-	1		
		07	-	11	-	1		
		08	-	12	-	1		
		09	-	13	-	1		
Output Resistance	Ro	10	_	14	_	mΩ	f=1kHz	
	'	12	-	16	-	11122		
Output Resistance			1		i	1		
Output Resistance			_	10	_			
Output Resistance		15	-	19	-			
Output Resistance			- - -	19 22 25	-			

# ● Electrical Characteristics BA78□□CP/FP

 $(Ta=25^{\circ}\text{C}, Vin=10\text{V}(05), 11\text{V}(06), 13\text{V}(07), 14\text{V}(08), 15\text{V}(09), 16\text{V}(10), 19\text{V}(12), 23\text{V}(15), 27\text{V}(18), 29\text{V}(20), 33\text{V}(24), lo=500\text{mA unless otherwise specified})$ 

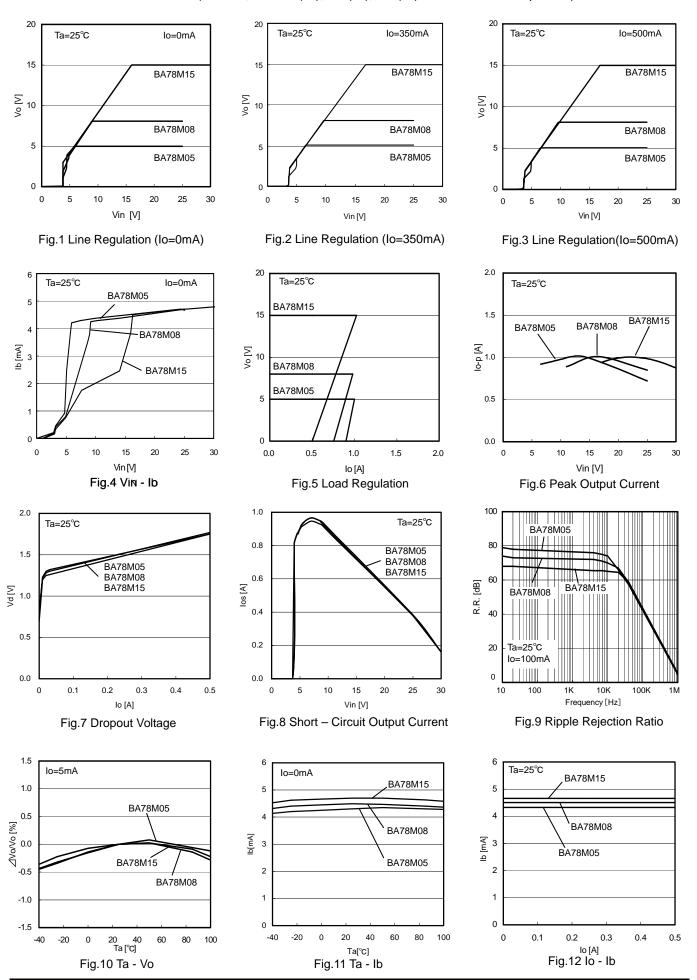
Parameter	Symbol	Туре	Min	Limit Typ	Max	Unit	Condition
		05	4.8	5.0	5.2		
		06	5.75	6.0	6.25		
		07	6.7	7.0	7.3		
		08	7.7	8.0	8.3		
		09	8.6	9.0	9.4		
Output Voltage 1	Vo1	10	9.6	10.0	10.4	V	Io=500mA
		12	11.5	12.0	12.5		
		15	14.4	15.0	15.6		
		18	17.3	18.0	18.7		
		20	19.2	20.0	20.8		
		24	23.0	24.0	25.0		Vin 7.5 - 20\/ la 5mA - 4A
		05 06	4.75 5.7	-	5.25 6.3		Vin=7.5~20V, Io=5mA~1A Vin=8.5~21V, Io=5mA~1A
		07	6.65	_	7.35		Vin=9.5~22V, Io=5mA~1A
		08	7.6	_	8.4		Vin=10.5~23V, Io=5mA~1A
		09	8.55	-	9.45		Vin=11.5~26V, lo=5mA~1A
Output Voltage 2	Vo2	10	9.5	-	10.5	V	Vin=12.5~25V, Io=5mA~1A
,		12	11.4	-	12.6		Vin=15~27V, Io=5mA~1A
		15	14.25	-	15.75		Vin=17.5~30V, Io=5mA~1A
		18	17.1	-	18.9		Vin=21~33V, Io=5mA~1A
		20	19.0	-	21.0		Vin=23~33V, Io=5mA~1A
		24	22.8	-	25.2		Vin=27~33V, Io=5mA~1A
		05	-	3	100		Vin=7~25V, Io=500mA
		06	-	4	120		Vin=8~25V, Io=500mA
		07	-	5	140		Vin=9~25V, Io=500mA
Line Regulation 1		08	-	5	160		Vin=10.5~25V, Io=500mA
	D 14	09	-	6	180		Vin=11.5~26V, lo=500mA
	Reg.I1	10 12	-	7 8	200	mV	Vin=12.5~27V, lo=500mA
		15	-	9	240 300		Vin=14.5~30V, Io=500mA Vin=17.5~30V, Io=500mA
		18	_	10	360		Vin=21~33V, Io=500mA
		20	_	12	400		Vin=23~33V, Io=500mA
		24	-	15	480		Vin=27~33V, Io=500mA
		05	-	1	50		Vin=8~12V, Io=500mA
		06	-	2	60		Vin=9~13V, Io=500mA
		07	-	2	70		Vin=10~15V, Io=500mA
		08	-	3	80		Vin=11~17V, Io=500mA
		09	-	4	90		Vin=13~19V, Io=500mA
Line Regulation 2	Reg.I2	10	-	4	100	mV	Vin=14~20V, Io=500mA
		12	-	5	120		Vin=16~22V, Io=500mA
		15	-	5	150		Vin=20~26V, Io=500mA
		18	-	5	180		Vin=24~30V, Io=500mA
		20	-	7	200		Vin=26~32V, Io=500mA
		24	- 62	10	240		Vin=30~33V, Io=500mA
		05 06	62 59	78 73	-		
		06	57	69	-		
		08	56	65	-		
		09	56	64	_		
Ripple Rejection	R.R.	10	55	64	-	dB	ein=1Vrms, f=120Hz,
11 21		12	55	63	-		lo=100mA
		15	54	62	-		
		18	53	61	-		
		20	53	60	-		
		24	50	58	-		
Temperature		05	-	-1.0	-		
Temperature Coefficient of	Tcvo	06/07/08/09/10/12	-	-0.5	-	mV/°C	lo=5mA, Tj=0~125°C
Output Voltage	1000	15/18	-	-0.6	-	1117/ 0	10-51117, 13-0 120 0
	<u> </u>	20/24	-	-0.7	-	_	
Peak Output Current	lo-p	common	-	1.7	-	A	Tj=25°C
Dropout Voltage	Vd	common	-	2.0	-	V	Io=1A

# ● Electrical Characteristics BA78□□CP/FP

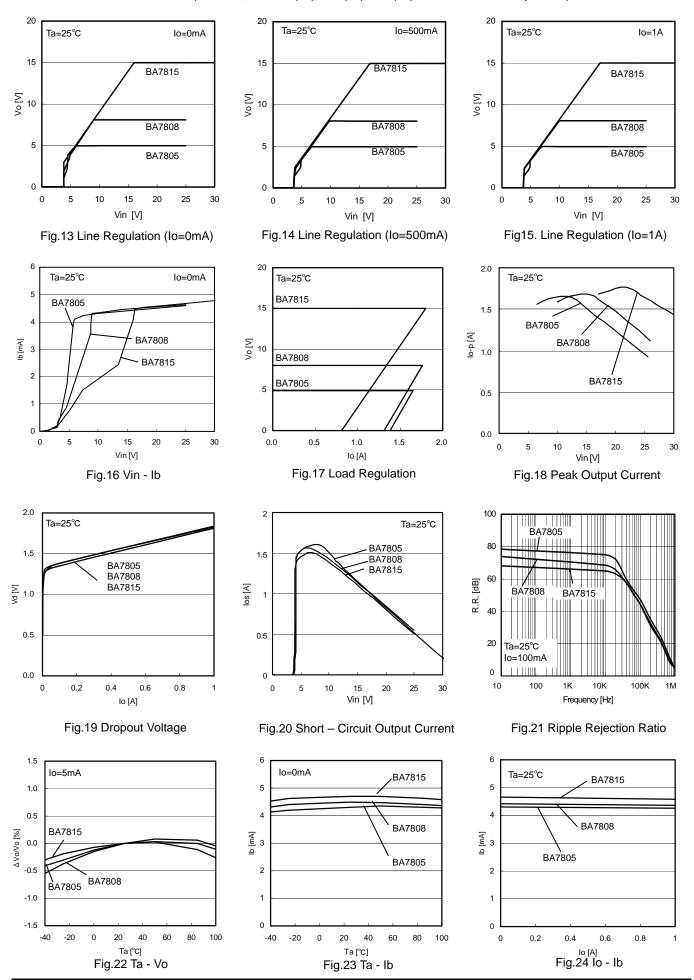
 $(Ta=25^{\circ}C, Vin=10V(05), 11V(06), 13V(07), 14V(08), 15V(09), 16V(10), 19V(12), 23V(15), 27V(18), 29V(20), 33V(24), Io=500mA \quad unless otherwise specified)$ 

(1a=25 C, VIII=10 V (05), 11 V (	T	1V(08),15V(09),16V(10),19V(12 	1,23 ( 13),21	Limit	20),33 V (24	),10=300IIIA	unless otherwise specified)
Parameter	Symbol	Туре	Min	Тур	Max	Unit	Condition
		05	-	15p	100		
		06		16	120		
			-				
		07	-	17	140	_	
		08	-	19	160	_	
		09	-	20	180	_	
Load Regulation 1	Reg.L1	10	-	21	200	mV	Io=5mA~1A
		12	-	23	200		
		15	-	27	300		
		18	-	30	360		
		20	-	32	400		
		24	-	37	480		
		05	-	5	50		
		06	-	6	60	-	
		07	_	6	70	-	
		08	-	7		-	
					80	4	
		09	-	8	90	.,	
Load Regulation 2	Reg.L2	10	-	8	90	mV	Io=250mA~750mA
		12	-	10	100		
		15	-	10	150		
		18	-	12	180		
		20	-	14	200		
		24	-	15	240		
		05	-	40	-		
		06	-	60	-	1	
		07	-	70	-	-	
		08	-	80	_	-	
						-	
Output Noise Voltage		09	-	90	-	.,	
	Vn	10	-	100	-	μV	f=10Hz~100kHz
· ·		12	-	110	-	_	
		15	-	125	-	_	
		18	-	140	-		
		20	-	150	-		
		24	-	180	-		
Bias Current	lb	common	-	4.5	8.0	mA	Io=0mA
Bias Current Change 1	lb1	common	-	-	0.5	mA	Io=5mA~1A
•		05	-	-	0.8		Vin:8~25V, Io=500mA
		06	-	-	0.8		Vin:8.5~25V, Io=500mA
		07	_	_	0.8	-	Vin:9.5~25V, Io=500mA
		08	_	_	0.8	-	Vin:10.5~25V, Io=500mA
						_	
D' O Ob O	11.0	09	-	-	0.8		Vin:11.5~26V, Io=500mA
Bias Current Change 2	lb2	10	-	-	0.8	mA	Vin:12.5~27V, Io=500mA
		12	-	-	0.8	_	Vin:14.5~30V, Io=500mA
		15	-	-	0.8		Vin:17.5~30V, Io=500mA
		18	-	-	0.8		Vin:21~33V, Io=500mA
		20	-	-	0.8		Vin:23~33V, Io=500mA
		24	-	-	0.8		Vin:27~33V, Io=500mA
Short-Circuit	1	05/06/07/08	-	0.6	-		Vin=25V
Output Current	los	09/10/12/15/18/20/24	-	0.3	-	Α	Vin=30V
		05	-	9	-		
		06		10	-	1	
		07		10	-	1	
						-	
		08		10	-	4	
	_	09	-	10	-		
Output Resistance	Ro	10	-	11	-	mΩ	f=1kHz
	Ro	12	-	12	-		
		15	-	14	-		
			-	14 17	-		
		15				-	

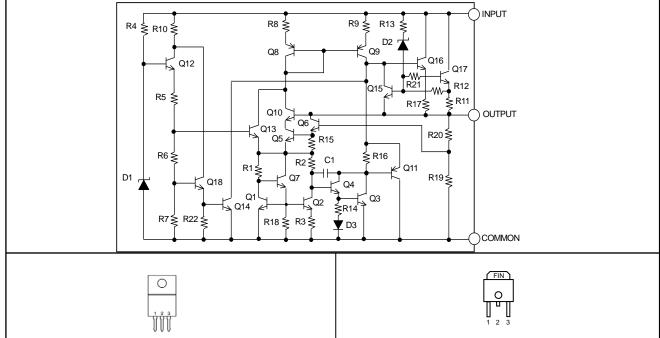
# ●BA78M□□ Characteristics data(Ta=25°C, Vin=10V(05), 14V(08), 23V(15) unless otherwise specified)



#### ●BA78□□ Characteristics data (Ta=25°C, Vin=10V(05), 14V(08), 23V(15) unless otherwise specified)



#### Internal Circuit Structural Diagram



TO220CP-3

PIN No.	Symbol	Function	
1	INPUT	Input terminal	
2	COMMON	Ground terminal	
3	OUTPUT	Output terminal	

 TO252-3

 PIN No.
 Symbol
 Function

 1
 INPUT
 Input terminal

 2
 N.C.
 Non connection terminal

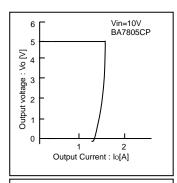
 3
 OUTPUT
 Output terminal

COMMON

#### Protection Circuit

# (1)Over-current protection circuit

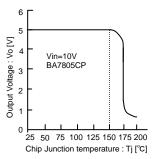
When the maximum rating current or more is rushed, it controls the current ability and protects the IC from destruction.



Ground terminal

# (2) Thermal shutdown circuit

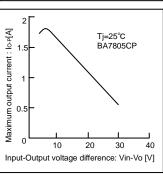
When the chip temperature of IC exceeds the setting temperature, the IC goes OFF, and it controls the IC not to be destroyed by the heat generation. It can be restored by being lowered the chip temperature of IC below the setting temperature.



#### (3) Safety operation area control circuit

It controls the output current in inverse proportion ratio to voltage difference (input-output).

When voltage difference becomes bigger, the IC will be destroyed in rush current. It protects the IC by controlling the current ability according to the voltage level.



#### Thermal design

Refer to the following thermal derating curves (Fig. 25, 26), when using in the status of Ta=25°C or more.

The characteristic of IC is greatly related to the operating temperature.

When it is used in over maximum junction temperature, the elements inside IC might become weaker and be destroyed. It is recommended to take into consideration thermal of IC.

Note that the temperatures are in the allowed temperature limits and operated within Pd.

It is necessary to operate it at junction temperature Tjmax or less to prevent IC from the thermal destruction.

Please operate IC within permissible loss Pd because the junction temperature Tj might become considerably a high temperature even if ambient temperature Ta is normal temperature (25°C).

Power consumption Pc(W) may be expressed by the equation shown below:

Pc=(Vin-Vo) × Io+ Vin × I b permissible loss Pd≧Pc

 $lo \le \frac{Pd - Vin \times lb}{Vin - Vo}$ 

Vin : Input Voltage
Vo : Output Voltage
Io : Output Current
Ib : Bias current

Maximum Output current lo<sub>MAX</sub> can be calculated in thermal design.

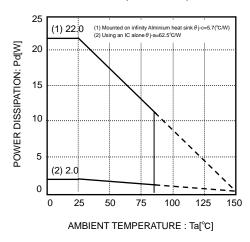
· Calculation example

Ex.1) Ta=85°C, Vin =7.5V, Vo=5.0V

$$lo \le \frac{1.04 - 7.5 \times 4.5m}{7.5 - 5.0}$$
  
 $lo \le 400mA$ 

Using TO220CP-3 alone  $\theta$  ja=62.5°C/W $\rightarrow$ 16mW/°C Pd=1.04W at 85°C

Be sure to use this IC within a power dissipation at the range of operating temperature.



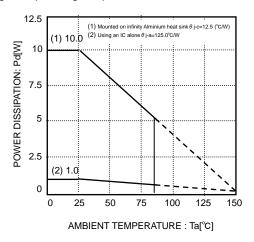


Fig.25 Thermal derating curve (TO220CP-3)

Fig.26 Thermal derating curve (TO252-3)

#### Terminal Setting and Cautions

#### INPUT

It is recommended that a capacitor (about 0.33uF) be inserted between INPUT and COMMON. The value of capacitor is designed suitable for the actual application.

#### OUTPUT

It is recommended that a capacitor (about 0.1uF) be inserted between OUTPUT and COMMON.

A tantalum capacitor can also be used for this pin because insufficient capacitors may cause oscillation by a temperature change.

#### COMMON

Keep the no voltage drop between Ground level of set board and IC.

When there is the voltage difference, setting voltage becomes inaccuracy and unstable.

It is recommended to connect by wide, short pattern, and lower the inpedance.

#### Notes for use

(1) Absolute Maximum Ratings

While utmost care is taken to quality control of this product, any application that may exceed some of the absolute maximum ratings including the voltage applied and the operating temperature range may result in breakage. If broken, short-mode or open-mode may not be identified. So if it is expected to encounter with special mode that may exceed the absolute maximum ratings, it is requested to take necessary safety measures physically including insertion of fuses.

(2) Ground voltage

Make setting of the potential of the GND terminal so that it will be maintained at the minimum in any operating state. Furthermore, check to be sure no terminals are at a potential lower than the GND voltage including an actual electric transient.

(3) Thermal design

When you do the kind of use which exceeds Pd, It may be happened to deteriorating IC original quality such as decrease of electric current ability with chip temperature rise. Do not exceed the power dissipation (Pd) of the package specification rating under actual operation, and please design enough temperature margins.

(4) Short-circuiting between terminals, and mismounting

When mounting to pc board, care must be taken to avoid mistake in its orientation and alignment. Failure to do so may result in IC breakdown. Short-circuiting due to foreign matters entered between output terminals, or between output and power supply or GND may also cause breakdown.

(5) Operation in Strong electromagnetic field

Be noted that using the IC in the strong electromagnetic radiation can cause operation failures.

(6) Inspection with the IC set to a pc board

If a capacitor must be connected to the pin of lower impedance during inspection with the IC set to a pc board, the capacitor must be discharged after each process to avoid stress to the IC. For electrostatic protection, provide proper grounding to assembling processes with special care taken in handling and storage. When connecting to jigs in the inspection process, be sure to turn OFF the power supply before it is connected and removed.

(7) Input to IC terminals

This is a monolithic IC with P<sup>+</sup> isolation between P-substrate and each element as illustrated below. This P-layer and the N-layer of each element form a P-N junction, and various parasitic element are formed.

If a resistor is joined to a transistor terminal as shown in Fig 28.

OP-N junction works as a parasitic diode if the following relationship is satisfied;

GND>Terminal A (at resistor side), or GND>Terminal B (at transistor side); and

Oif GND>Terminal B (at NPN transistor side),

a parasitic NPN transistor is activated by N-layer of other element adjacent to the above-mentioned parasitic diode. The structure of the IC inevitably forms parasitic elements, the activation of which may cause interference among circuits, and/or malfunctions contributing to breakdown. It is therefore requested to take care not to use the device in such manner that the voltage lower than GND (at P-substrate) may be applied to the input terminal, which may result in activation of parasitic elements.

(8) Ground wiring pattern

If small-signal GND and large-current GND are provided, It will be recommended to separate the large-current GND pattern from the small-signal GND pattern and establish a single ground at the reference point of the set PCB so that resistance to the wiring pattern and voltage fluctuations due to a large current will cause no fluctuations in voltages of the small-signal GND. Pay attention not to cause fluctuations in the GND wiring pattern of external parts as well.

(9) Thermal shutdown circuit

A temperature control circuit is built in the IC to prevent the damage due to overheat. Therefore, the output is turned off when the thermal circuit works and is turned on when the temperature goes down to the specified level.

But, built-in the IC a temperature control circuit to protect itself, and avoid the design used the thermal protection.

(10) Over current protection circuit

The over-current protection circuits are built in at output, according to their respective current outputs and prevent the IC from being damaged when the load is short-circuited or over-current. But, these protection circuits are effective for preventing destruction by unexpected accident. When it's in continuous protection circuit moving period don't use please. And for ability, because this chip has minus characteristic, be careful for heat plan.

(11) There is a possibility to damage an internal circuit or the element when Vin and the voltage of each terminal reverse in the application. For instance, Vin is short-circuited to GND etc. with the charge charged to an external capacitor. Please use the capacitor of the output terminal with 1000µF or less. Moreover, the Vin series is recommended to insert the diode of the by-pass the diode of the backflow prevention or between each terminal and Vin.

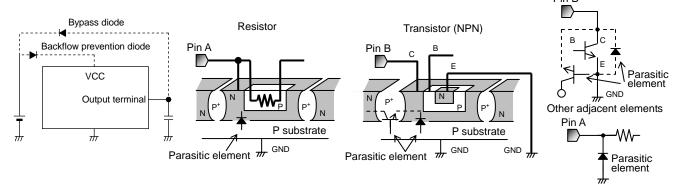
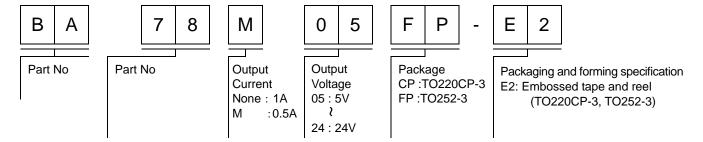


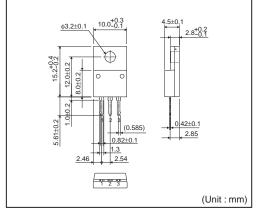
Fig.27 Bypass Diode

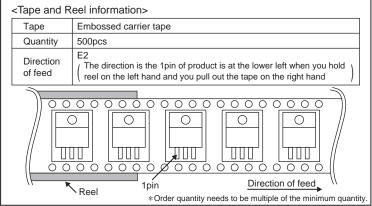
Fig.28 Simplified structure of monorisic IC

# Ordering part number

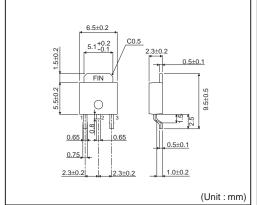


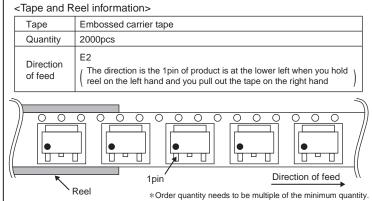
#### TO220CP-3





# TO252-3





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JAPAN	USA	EU	CHINA
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CLASSIV		CLASSⅢ	

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  - [e] Use of our Products in proximity to heat-producing components, plastic cords, or other flammable items
  - [f] Sealing or coating our Products with resin or other coating materials
  - [g] Use of our Products without cleaning residue of flux (even if you use no-clean type fluxes, cleaning residue of flux is recommended); or Washing our Products by using water or water-soluble cleaning agents for cleaning residue after soldering
  - [h] Use of the Products in places subject to dew condensation
- 4. The Products are not subject to radiation-proof design.
- 5. Please verify and confirm characteristics of the final or mounted products in using the Products.
- 6. In particular, if a transient load (a large amount of load applied in a short period of time, such as pulse. is applied, confirmation of performance characteristics after on-board mounting is strongly recommended. Avoid applying power exceeding normal rated power; exceeding the power rating under steady-state loading condition may negatively affect product performance and reliability.
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  - the Products are exposed to direct sunshine or condensation
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- Use Products within the specified time after opening a humidity barrier bag. Baking is required before using Products of which storage time is exceeding the recommended storage time period.

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